# T499 Automotive Grade MnO<sub>2</sub> 175°C



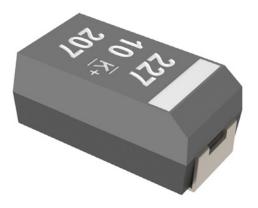
#### **Overview**

The KEMET T499 is a high-temperature product that offers optimum performance characteristics in applications with operating temperatures up to 175°C. Advanced materials and testing allow this series to perform with a reliability level of 0.5%/1000 hours at rated voltage and temperature.

T499 AUTO is classified as having moisture sensitivity level (MSL) 1 under J STD 020: unlimited floorlife time at ≤ 30°C/85% RH. T499 AUTO is available in five standard EIA case sizes, with ROHS-compliant terminations as standard.

#### **Benefits**

- Meets or exceeds EIA Standard 535BAAC
- Tape & Reel standard packaging per EIA 481
- · Symmetrical, compliant terminations
- · Optional gold-plated terminations
- · Laser-marked case
- · 100% surge current testing
- · Complies with AEC-Q200
- · 100% steady-state accelerated aging
- Voltage derating is 1/2 at 175°C



# **Applications**

Typical applications include decoupling and filtering in industrial and automotive end applications, such as DC/DC converters, portable electronics, telecommunications, and control units operating at temperatures up to 175°C.

## **Environmental Compliance**

RoHS compliant (6/6) according to Directive 2002/95/EC when ordered with 100% Sn solder or gold-plated.

- · Halogen-free
- Epoxy compliant with UL94 V-0
- Molded Epoxy complies for outgassing testing under ASTM E 595.



#### K-SIM

For a detailed analysis of specific part numbers, please visit ksim.kemet.com to access KEMET's K-SIM software. KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels.

# **Ordering Information**

Т	499	X	227	M	010	Α	T	E500	
Capacitor Class	Series	Case Size	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VDC)	Failure Rate/ Design	Termination Finish	ESR	Packaging (C-Spec)
T = Tantalum	High Temperature 175°C	A B C D X	First two digits represent significant figures. Third digit specifies number of zeros.	K = ±10% M = ±20%	006 = 6.3 010 = 10 016 = 16 020 = 20 025 = 25 035 = 35 050 = 50	A = N/A	T = 100% Matte tin (Sn)-plated G = Gold-plated H = Standard solder coated (SnPb 5% Pb minimum)	$E = ESR$ Last three digits specify $ESR \text{ in } m\Omega$ $(500 = 500 \text{ m}\Omega)$	Blank = 7" reel 7280 = 13" reel 7027 = Moisture barrier bag

#### **Performance Characteristics**

Item	Performance Characteristics					
Operating Temperature	-55°C to 175°C					
Rated Capacitance Range	0.15 - 220 μF at 120 Hz/25°C					
Capacitance Tolerance	K tolerance (10%), M tolerance (20%)					
Rated Voltage Range	6 – 50 V					
DF (120 Hz)	Refer to Part Number Electrical Specification Table					
ESR (100 kHz)	Refer to Part Number Electrical Specification Table					
Leakage Current	≤ 0.01 CV (µA) at rated voltage after 5 minutes					



# Qualification

Test	Condition			Charact	teristics			
			Δ C/C	Within ±10%	6 of initial valu	е		
Endurance	175°C at 1/2 rated valtage 2 000 hours	DF	Within initial limits					
Endurance	175°C at 1/2 rated voltage, 2,000 hours		DCL	Within 1.25	x initial limit			
		ESR	Within initia	al limits				
			Δ C/C	Within ±10%	6 of initial valu	e		
Storago Lifo	175°C at 0 volts, 2,000 hours		DF	Within initia	al limits			
Storage Life	173 C at 0 voits, 2,000 flours		DCL	Within 1.25	x initial limit			
			ESR	Within initia	al limits			
			Δ C/C	Within ±5%	of initial value			
Thermal Shock	MIL-STD-202, Method 107, Condition B, mo	ounted,	DF	Within initial limits				
Thermal Shock	-55°C to 175°C, 1,000 cycles		DCL	Within 1.25	x initial limit			
			ESR	Within initia	al limits			
			+25°C	-55°C	+85°C	+175°C		
Temperature Stability	Extreme temperature exposure at a succession of continuous steps at +25°C,	ΔC/C	IL*	±10%	±10%	±30%		
reinperature Stability	-55°C, +25°C, +85°C, +175°C, +25°C	DF	IL	IL	1.5 x IL	1.5 x IL		
		DCL	IL	N/A	10 x IL	12 x IL		
			Δ C/C	Within ±5%	of initial value			
Surge Voltage	85°C, 1.32 x rated voltage 1,000 cycles		DF	Within initia	al limits			
Surge voltage	(150°C, 1.2 x rated voltage)		DCL	Within initial limits				
			ESR	Within initial limits				
	MIL-STD-202, Method 213, Figure 1, Conditio	n F, 1,500 G	Δ C/C	Within ±10%	6 of initial valu	e		
Mechanical Shock/ Vibration	peak MIL-STD-202, Method 214, 5g for 20 minut	es/12	DF	Within initia	Within initial limits			
	cycles each of 3 orientations. Test from 10 t		DCL	Within initia	al limits			

<sup>\*</sup>IL = Initial Limit

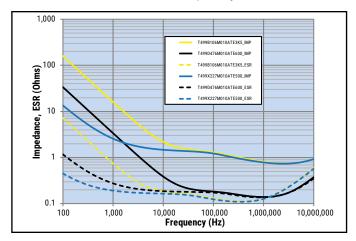
## Certification

KEMET's Internal Qualification Plan for this Tantalum series of capacitors follows AEC-Q200 guidelines.

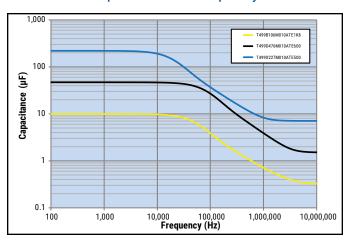


#### **Electrical Characteristics**

ESR vs. Frequency

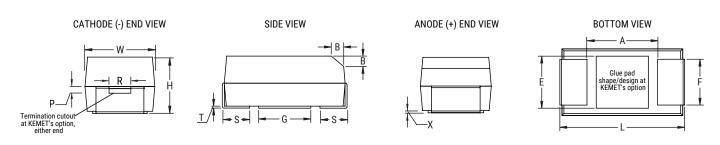


## Capacitance vs. Frequency



# **Dimensions - Millimeters (Inches)**

Metric will govern



Case	Size		Component											
KEMET	EIA	L	W	Н	F ±0.1 ±(0.004)	S ±0.3 ±(0.012)	B ±0.15(Ref) ±0.006	X (Ref)	P (Ref)	R (Ref)	T (Ref)	A (Min)	G (Ref)	E (Ref)
Α	3216-18	3.2±0.2 (0.126±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	1.2 (0.047)	0.8 (0.031)	0.4 (0.016)	0.10±0.10 (0.004±0.004)	0.4 (0.016)	0.4 (0.016)	0.13 (0.005)	1.2 (0.047)	1.1 (0.043)	1.3 (0.051)
В	3528-21	3.5±0.2 (0.138±0.008)	2.8±0.2 (0.110±0.008)	1.9±0.2 (0.075±0.008)	2.2 (0.087)	0.8 (0.031)	0.4 (0.016)	0.10±0.10 (0.004±0.004)	0.5 (0.020)	1.0 (0.039)	0.13 (0.005)	1.9 (0.075)	1.8 (0.071)	2.2 (0.087)
С	6032-28	6.0±0.3 (0.236±0.012)	3.2±0.3 (0.126±0.012)	2.5±0.3 (0.098±0.012)	2.2 (0.087)	1.3 (0.051)	0.5 (0.020)	0.10±0.10 (0.004±0.004)	0.9 (0.035)	1.0 (0.039)	0.13 (0.005)	3.1 (0.122)	2.8 (0.110)	2.4 (0.094)
D	7343-31	7.3±0.3 (0.287±0.012)	4.3±0.3 (0.169±0.012)	2.8±0.3 (0.110±0.012)	2.4 (0.094)	1.3 (0.051)	0.5 (0.020)	0.10±0.10 (0.004±0.004)	0.9 (0.035)	1.0 (0.039)	0.13 (0.005)	3.8 (0.150)	3.5 (0.138)	3.5 (0.138)
Х	7343-43	7.3±0.3 (0.287±0.012)	4.3±0.3 (0.169±0.012)	4.0±0.3 (0.157±0.012)	2.4 (0.094)	1.3 (0.051)	0.5 (0.020)	0.10±0.10 (0.004±0.004)	1.7 (0.067)	1.0 (0.039)	0.13 (0.005)	3.8 (0.150)	3.5 (0.138)	3.5 (0.138)

Notes: (Ref) – Dimensions provided for reference only.



# **Table 1 - Ratings & Part Number Reference**

Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR		mum Allo e Curren		Maximum Operating Temp	MSL
VDC at 85°C	μF	KEMET/EIA	(See below for part options)	μA at +25°C Max/5 Min	% at +25°C 120 Hz Max	mΩ at +25°C 100 kHz Max	mA at +25°C 100 kHz	mA at +85°C 100 kHz	mA at +125°C 100 kHz	°C	Reflow Temp ≤ 260°C
6.3	4.7	A/3216-18	T499A475(1)006A(2)E6K0	0.5	6	6,000	112	101	45	175	1
6.3	6.8	B/3528-21	T499B685(1)006A(2)E3K5	0.5	6	3500	156	140.4	62.4	175 175	1 1
6.3 6.3	10 15	B/3528-21 B/3528-21	T499B106(1)006A(2)E3K5 T499B156(1)006A(2)E3K5	0.6 0.9	6 6	3,500 3,500	156 156	140 140	62 62	175	1
6.3	22	B/3528-21	T499B130(1)000A(2)E3K5	1.4	6	3,500	156	140	62	175	1
6.3	22	C/6032-28	T499C226(1)006A(2)E1K8	1.4	6	1,800	247	222	99	175	1
6.3	33	B/3528-21	T499B336(1)006A(2)E3K0	2.1	6	3,000	168	151	67	175	1
6.3	33	C/6032-28	T499C336(1)006A(2)E1K8	2.1	6	1,800	247	222	99	175	1
6.3	47	C/6032-28	T499C476(1)006A(2)E1K8	3.0	6	1,800	247	222	99	175	1
6.3	47	D/7343-31	T499D476(1)006A(2)E800	3.0	6	800	433	390	173	175	1
6.3	68	C/6032-28	T499C686(1)006A(2)E1K2	4.3	6	1,200	303	273	121	175	1
6.3	100	D/7343-31	T499D107(1)006A(2)E800	6.3	8	800	433	390	173	175	1
6.3	150	D/7343-31	T499D157(1)006A(2)E700	9.5	8	700	463	417	185	175	1
10	1.5	A/3216-18	T499A155(1)010A(2)E8K0	0.5	6	8,000	97	87	39	175	1
10	2.2	A/3216-18	T499A225(1)010A(2)E8K0	0.5	6	8,000	97	87	39	175	1
10	3.3	A/3216-18	T499A335(1)010A(2)E6K0	0.5	6	6,000	112	101	45	175	1
10 10	4.7 4.7	A/3216-18 B/3528-21	T499A475(1)010A(2)E6K0	0.5 0.5	6 6	6,000	112 156	101 140	45 62	175 175	1 1
10	6.8	A/3216-18	T499B475(1)010A(2)E3K5 T499A685(1)010A(2)E6K0	0.5	6	3,500 6,000	112	101	45	175	1
10	6.8	B/3528-21	T499B685(1)010A(2)E3K5	0.7	6	3,500	156	140	62	175	1
10	10	B/3528-21	T499B106(1)010A(2)E3K5	1.0	6	3,500	156	140	62	175	1
10	10	C/6032-28	T499C106(1)010A(2)E1K8	1.0	6	1,800	247	222	99	175	1
10	15	B/3528-21	T499B156(1)010A(2)E3K5	1.5	6	3,500	156	140	62	175	1
10	15	C/6032-28	T499C156(1)010A(2)E1K8	1.5	6	1,800	247	222	99	175	1
10	22	B/3528-21	T499B226(1)010A(2)E3K0	2.2	6	3,000	168	151	67	175	1
10	22	C/6032-28	T499C226(1)010A(2)E1K8	2.2	6	1,800	247	222	99	175	1
10	33	C/6032-28	T499C336(1)010A(2)E1K8	3.3	6	1,800	247	222	99	175	1
10	33	D/7343-31	T499D336(1)010A(2)E1K6	3.3	6	1,600	306	275	122	175	1
10	47	D/7343-31	T499D476(1)010A(2)E800	4.7	6	800	433	390	173	175	1
10 10	68	D/7343-31	T499D686(1)010A(2)E800	6.8	6 8	800	433 463	390	173 185	175 175	1
10	100 220	D/7343-31 X/7343-43	T499D107(1)010A(2)E700 T499X227(1)010A(2)E500	10.0 22.0	8	700 500	574	417 517	230	175	1
16	1	A/3216-18	T499A105(1)016A(2)E10K	0.5	4	10,000	87	78	35	175	1
16	1.5	A/3216-18	T499A155(1)016A(2)E8K0	0.5	6	8,000	97	87	39	175	1
16	2.2	A/3216-18	T499A225(1)016A(2)E6K0	0.5	6	6,000	112	101	45	175	1
16	3.3	A/3216-18	T499A335(1)016A(2)E6K0	0.5	6	6,000	112	101	45	175	1
16	3.3	B/3528-21	T499B335(1)016A(2)E3K5	0.5	6	3,500	156	140	62	175	1
16	4.7	B/3528-21	T499B475(1)016A(2)E6K0	0.8	6	6,000	119	107	48	175	1
16	6.8	A/3216-18	T499A685(1)016A(2)E7K0	1.1	6	7,000	104	94	42	175	1
16	6.8	B/3528-21	T499B685(1)016A(2)E3K5	1.1	6	3,500	156	140	62	175	1
16	6.8	C/6032-28	T499C685(1)016A(2)E1K8	1.1	6	1,800	247	222	99	175	1
16	10	B/3528-21	T499B106(1)016A(2)E3K5	1.6	6	3,500	156	140	62	175	1
16	10	C/6032-28 C/6032-28	T499C106(1)016A(2)E1K8 T499C156(1)016A(2)E1K8	1.6 2.4	6	1,800	247	222	99 99	175	1
16 16	15 22	C/6032-28 C/6032-28	T499C156(1)016A(2)E1K8	3.5	6 6	1,800 1,600	247 262	222 236	105	175 175	1 1
16	22	D/7343-31	T499D226(1)016A(2)E800	3.5	6	800	433	390	173	175	1
16	33	D/7343-31	T499D336(1)016A(2)E800	5.3	6	800	433	390	173	175	1
VDC at 85°C	μF	KEMET/EIA	(See below for part options)	μA at +25°C Max/5 Min	% at +25°C 120 Hz Max	mΩ at +25°C 100 kHz Max	mA at +25°C 100	mA at +85°C 100	mA at +125°C 100	°C	Reflow Temp ≤ 260°C
Rated Voltage	Rated Cap	Case Code/ Case Size	KEMET Part Number	DC Leakage	DF	ESR	kHz   kHz   kHz  Maximum Allowable Ripple Current (rms)		Maximum Operating Temp	MSL	

Refer to Ordering Information for additional detail.

Higher voltage ratings and tighter tolerance product including ESR may be substituted within the same size at KEMET's option. Voltage substitution will be marked with the higher voltage rating. Substitutions can include better than series.

<sup>(1)</sup> To complete KEMET part number, insert M for ±20% or K for ±10%. Designates Capacitance tolerance.
(2) To complete KEMET part number, insert T = 100% Matte Tin (Sn) Plated, G = Gold Plated, H = Standard Solder coated (SnPb 5% Pb minimum).
Designates Termination Finish.



# Table 1 - Ratings & Part Number Reference cont.

		Caca									
Detect	Datad	Case	VEMET Don't	DO			Manda	A II.		Maximum	
Rated	Rated	Code/	KEMET Part	DC	DF	ESR		mum Allo		Operating	MSL
Voltage	Cap	Case	Number	Leakage			Rippl	e Curren	t (rms)	Temp	
		Size								Temp	
VDC at 85°C	μF	KEMET/EIA	(See below for part options)	μA at +25°C Max/5 Min	% at +25°C 120 Hz Max	mΩ at +25°C 100 kHz Max	mA at +25°C 100 kHz	mA at +85°C 100 kHz	mA at +125°C 100 kHz	°C	Reflow Temp ≤ 260°C
16	47	D/7343-31	T499D476(1)016A(2)E800	7.5	6	800	433	390	173	175	1
16	100	X/7343-43	T499X107(1)016A(2)E300	16.0	6	300	742	668	297	175	1
20 20	0.68 1	A/3216-18 A/3216-18	T499A684(1)020A(2)E12K T499A105(1)020A(2)E10K	0.5 0.5	4	12,000 10,000	79 87	71 78	32 35	175 175	1
20	1.5	A/3216-18 A/3216-18	T499A155(1)020A(2)E8K0	0.5	6	8,000	97	87	39	175	1
20	2.2	B/3528-21	T499B225(1)020A(2)E3K5	0.5	6	3,500	156	140	62	175	1
20	3.3	B/3528-21	T499B335(1)020A(2)E3K5	0.7	6	3,500	156	140	62	175	1
20	4.7	B/3528-21	T499B475(1)020A(2)E3K5	0.9	6	3,500	156	140	62	175	1
20	4.7	C/6032-28	T499C475(1)020A(2)E2K4	0.9	6	2,400	214	193	86	175	1
20	6.8	C/6032-28	T499C685(1)020A(2)E1K9	1.4	6	1,900	241	217	96	175	1
20	10	C/6032-28	T499C106(1)020A(2)E1K8	2.0	6	1,800	247	222	99	175	1
20	15	C/6032-28	T499C156(1)020A(2)E1K7	3.0	6	1,700	254	229	102	175	1
20	15	D/7343-31	T499D156(1)020A(2)E1K0	3.0	6	1,000	387	348	155	175	1
20	22	D/7343-31	T499D226(1)020A(2)E800	4.4	6	800	433	390	173	175	1
25	0.47	A/3216-18	T499A474(1)025A(2)E14K	0.5	4	14,000	73	66	29	175	1
25	0.68	A/3216-18	T499A684(1)025A(2)E10K	0.5	4	10,000	87	78	35	175	1
25	1	A/3216-18	T499A105(1)025A(2)E8K0	0.5	4	8,000	97	87	39	175	1 1
25 25	1.5 2.2	A/3216-18 B/3528-21	T499A155(1)025A(2)E5K0	0.5 0.6	6	5,000	122 137	110 123	49 55	175 175	1
25 25	3.3	C/6032-28	T499B225(1)025A(2)E4K5 T499C335(1)025A(2)E2K5	0.8	6	4,500 2,500	210	189	84	175	1
25	4.7	C/6032-28	T499C475(1)025A(2)E2K4	1.2	6	2,400	214	193	86	175	1
25	6.8	C/6032-28	T499C685(1)025A(2)E1K9	1.7	6	1,900	241	217	96	175	1
25	6.8	D/7343-31	T499D685(1)025A(2)E1K1	1.7	6	1,100	369	332	148	175	1
25	10	C/6032-28	T499C106(1)025A(2)E1K5	2.5	6	1,500	271	244	108	175	1
25	10	D/7343-31	T499D106(1)025A(2)E1K0	2.5	6	1,000	387	348	155	175	1
25	15	D/7343-31	T499D156(1)025A(2)E1K0	3.8	6	1,000	387	348	155	175	1
25	22	D/7343-31	T499D226(1)025A(2)E800	5.5	6	800	433	390	173	175	1
25	33	D/7343-31	T499D336(1)025A(2)E700	8.3	6	700	463	417	185	175	1
35	0.15	A/3216-18	T499A154(1)035A(2)E19K	0.5	4	19,000	63	57	25	175	1
35	0.22	A/3216-18	T499A224(1)035A(2)E18K	0.5	4	18,000	65	59	26	175	1
35	0.33	A/3216-18	T499A334(1)035A(2)E15K	0.5	4	15,000	71	64	28	175	1
35	0.47	B/3528-21	T499B474(1)035A(2)E8K0	0.5	4	8,000	103	93	41	175	1
35 35	0.68 1	B/3528-21 A/3216-18	T499B684(1)035A(2)E6K5	0.5 0.5	4	6,000 10,000	119 87	107 78	48 35	175 175	1
35 35	1	B/3528-21	T499A105(1)035A(2)E10K T499B105(1)035A(2)E5K0	0.5	4	5,000	130	117	52	175	1
35	1.5	C/6032-28	T499C155(1)035A(2)E4K5	0.5	6	4,500	156	140	62	175	1
35	2.2	C/6032-28	T499C135(1)035A(2)E4K5	0.8	6	3,500	177	159	71	175	1
35	3.3	C/6032-28	T499C335(1)035A(2)E2K5	1.2	6	2,500	210	189	84	175	1
35	4.7	C/6032-28	T499C475(1)035A(2)E2K5	1.6	6	2,500	210	189	84	175	1
35	4.7	D/7343-31	T499D475(1)035A(2)E1K5	1.6	6	1,500	316	284	126	175	1
35	4.7	D/7343-31	T499D475(1)035A(2)E1K0	1.6	6	1,000	387	348	155	175	1
35	4.7	D/7343-31	T499D475(1)035A(2)E900	1.6	6	900	408	367	163	175	1
35	6.8	D/7343-31	T499D685(1)035A(2)E1K3	2.4	6	1,300	340	306	136	175	1
35	10	D/7343-31	T499D106(1)035A(2)E1K0	3.5	6	1,000	387	348	155	175	1
35	22	X/7343-43	T499X226(1)035A(2)E700	7.7	6	700	486	437	194	175	1
35	33	X/7343-43	T499X336(1)035A(2)E600	11.6	6	600	524	472	210	175	1
50 50	3.3 4.7	D/7343-31 D/7343-31	T499D335(1)050A(2)E2K0 T499D475(1)050A(2)E900	1.7 2.4	6 4.5	2,000 900	274 408	247 367	110 163	175 175	1 1
50 50	10	D/7343-31 D/7343-31	T499D106(1)050A(2)E1K0	5.0	6	1,000	387	348	155	175	1
VDC at 85°C	μF	KEMET/EIA	(See below for	μA at +25°C Max/5 Min	% at +25°C 120 Hz	mΩ at +25°C 100 kHz	mA at +25°C 100	mA at +85°C 100	mA at +125°C 100	°C	Reflow Temp
Rated Voltage	Rated Cap	Case Code/ Case Size	part options)  KEMET Part Number	DC Leakage	Max DF	Max ESR	kHz kHz kHz  Maximum Allowable Ripple Current (rms)		Maximum Operating Temp	≤ 260°C MSL	

Refer to Ordering Information for additional detail.

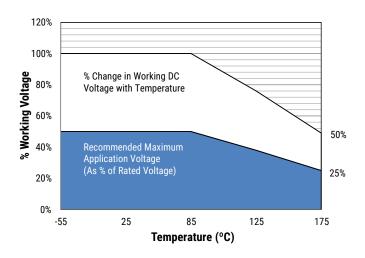
Higher voltage ratings and tighter tolerance product including ESR may be substituted within the same size at KEMET's option. Voltage substitution will be marked with the higher voltage rating. Substitutions can include better than series.

<sup>(1)</sup> To complete KEMET part number, insert M for ±20% or K for ±10%. Designates Capacitance tolerance.
(2) To complete KEMET part number, insert T = 100% Matte Tin (Sn) Plated, G = Gold Plated, H = Standard Solder coated (SnPb 5% Pb minimum). Designates Termination Finish.



### **Recommended Voltage Derating Guidelines**

Rated Voltage	Working	Voltage	Recommended Application Voltage (for maximum reliability)				
	85°C	175°C	85°C	175°C			
6.3	<b>6.3</b> 6.3 3.15		3.15	1.58			
10	10	5.00	5	2.50			
16	16	8.00	8	4.00			
20	20	10.00	10	5.00			
25	25	12.50	12.5	6.25			
35	35	17.50	17.5	8.75			
50	50	25.00	25	12.50			



## **Ripple Current/Ripple Voltage**

Permissible AC ripple voltage and current are related to equivalent series resistance (ESR) and the power dissipation capabilities of the device. Permissible AC ripple voltage which may be applied is limited by two criteria:

- 1. The positive peak AC voltage plus the DC bias voltage, if any, must not exceed the DC voltage rating of the capacitor.
- 2. The negative peak AC voltage in combination with bias voltage, if any, must not exceed the allowable limits specified for reverse voltage. See the Reverse Voltage section for allowable limits.

The maximum power dissipation by case size can be determined using the table at right. The maximum power dissipation rating stated in the table must be reduced with increasing environmental operating temperatures. Refer to the table below for temperature compensation requirements.

Temp		ensation Multip Ripple Current	oliers		
T ≤ 25°C	T ≤ 85°C	T ≤ 125°C	T ≤ 175°C		
1.00	0.40	0.20			

T= Environmental Temperature

The maximum power dissipation rating must be reduced with increasing environmental operating temperatures. Refer to the Temperature Compensation Multiplier table for details.

KEMET Series and Case Code	EIA Case Code	Maximum Power Dissipation (P max) mWatts at 25°C with +20°C Rise			
Α	3216-18	75			
В	3528-21	85			
С	6032-28	110			
D	7343-31	150			
Х	7343-43	165			
E	7360-38	200			
S	3216-12	60			
T	3528-12	70			
U	6032-15	90			
V	7343-20	125			
T510X	7343-43	270			
T510E	7360-38	285			

Using the P max of the device, the maximum allowable rms ripple current or voltage may be determined.

$$I(max) = \sqrt{P max/R}$$
  
$$E(max) = Z \sqrt{P max/R}$$

I = rms ripple current (amperes)

E = rms ripple voltage (volts)

P max = maximum power dissipation (watts)

R = ESR at specified frequency (ohms)

Z = Impedance at specified frequency (ohms)



#### **Reverse Voltage**

Solid tantalum capacitors are polar devices and may be permanently damaged or destroyed if connected with the wrong polarity. The positive terminal is identified on the capacitor body by a stripe plus in some cases a beveled edge. A small degree of transient reverse voltage is permissible for short periods per the table. The capacitors should not be operated continuously in reverse mode, even within these limits.

Temperature	<b>Permissible Transient Reverse Voltage</b>
25°C	15% of Rated Voltage
85°C	5% of Rated Voltage
125°C	1% of Rated Voltage

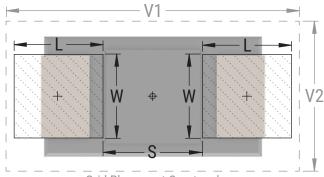
## **Table 2 - Land Dimensions/Courtyard**

KEMET	Metric Size Code	Density Level A: Maximum (Most) Land Protrusion (mm)			Density Level B: Median (Nominal) Land Protrusion (mm)				Density Level C: Minimum (Least) Land Protrusion (mm)							
Case	EIA	W	L	S	V1	V2	W	L	S	V1	V2	W	L	S	V1	V2
Α	3216-18	1.35	2.20	0.62	6.02	2.80	1.23	1.80	0.82	4.92	2.30	1.13	1.42	0.98	4.06	2.04
В	3528-21	2.35	2.21	0.92	6.32	4.00	2.23	1.80	1.12	5.22	3.50	2.13	1.42	1.28	4.36	3.24
С	6032-28	2.35	2.77	2.37	8.92	4.50	2.23	2.37	2.57	7.82	4.00	2.13	1.99	2.73	6.96	3.74
D	7343-31	2.55	2.77	3.67	10.22	5.60	2.43	2.37	3.87	9.12	5.10	2.33	1.99	4.03	8.26	4.84
<b>X</b> <sup>1</sup>	7343-43	2.55	2.77	3.67	10.22	5.60	2.43	2.37	3.87	9.12	5.10	2.33	1.99	4.03	8.26	4.84

**Density Level A:** For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes.

**Density Level B:** For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC standard 7351 (IPC-7351).

<sup>&</sup>lt;sup>2</sup> Land pattern geometry is too small for silkscreen outline.



**Grid Placement Courtyard** 

<sup>&</sup>lt;sup>1</sup> Height of these chips may create problems in wave soldering.



#### **Soldering Process**

The KEMET families of surface mount capacitors are compatible with wave (single or dual), convection, IR, or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020D standard for moisture sensitivity testing. The devices can safely withstand a maximum of three reflow passes at these conditions.

Please note that although the X/7343-43 case size can withstand wave soldering, the tall profile (4.3 mm maximum) dictates care in wave process development.

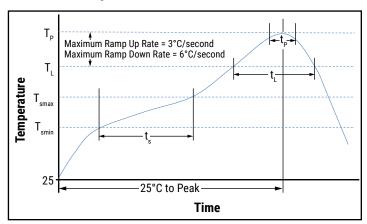
Hand soldering should be performed with care due to the difficulty in process control. If performed, care should be taken to avoid contact of the soldering iron to the molded case. The iron should be used to heat the solder pad, applying solder between the pad and the termination, until reflow occurs. Once reflow occurs, the iron should be removed immediately. "Wiping" the edges of a chip and heating the top surface is not recommended.

During typical reflow operations, a slight darkening of the gold-colored epoxy may be observed. This slight darkening is normal and not harmful to the product. Marking permanency is not affected by this change.

Profile Feature	SnPb Assembly	Pb-Free Assembly
Preheat/Soak		
Temperature Minimum (T <sub>Smin</sub> )	100°C	150°C
Temperature Maximum (T <sub>Smax</sub> )	150°C	200°C
Time $(t_s)$ from $T_{smin}$ to $T_{smax}$ )	60 - 120 seconds	60 – 120 seconds
Ramp-up Rate $(T_L \text{ to } T_P)$	3°C/second maximum	3°C/second maximum
Liquidous Temperature (T <sub>L</sub> )	183°C	217°C
Time Above Liquidous (t <sub>L</sub> )	60 - 150 seconds	60 – 150 seconds
Peak Temperature (T <sub>P</sub> )	220°C* 235°C**	250°C* 260°C**
Time within 5°C of Maximum Peak Temperature (t <sub>P</sub> )	20 seconds maximum	30 seconds maximum
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second maximum	6°C/second maximum
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum

Note: All temperatures refer to the center of the package, measured on the package body surface that is facing up during assembly reflow.

<sup>\*\*</sup> For Case Size height ≤ 2.5 mm



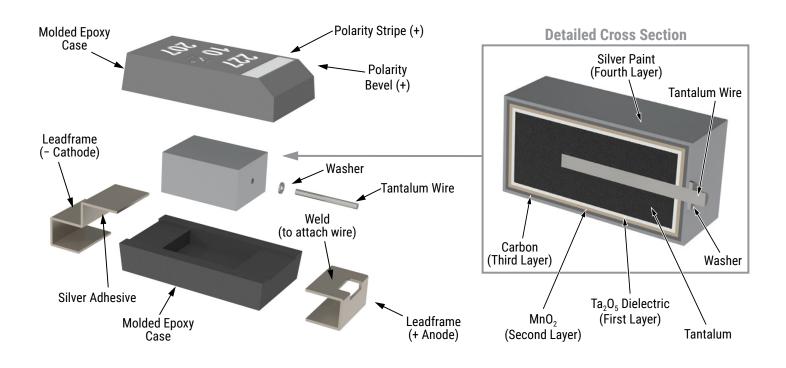
## **Storage**

Tantalum chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature – reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 60% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulphur bearing compounds. For optimized solderability, chip stock should be used promptly, preferably within three years of receipt.

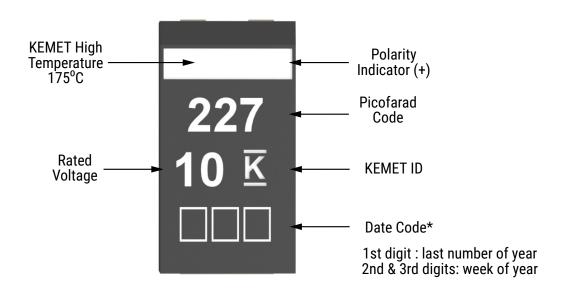
<sup>\*</sup> For Case Size height > 2.5 mm



#### Construction



# **Capacitor Marking**





### **Tape & Reel Packaging Information**

KEMET's molded chip capacitor families are packaged in 8 and 12 mm plastic tape on 7" and 13" reels in accordance with EIA Standard 481: Embossed Carrier Taping of Surface Mount Components for Automatic Handling. This packaging system is compatible with all tape-fed automatic pick-and-place systems.

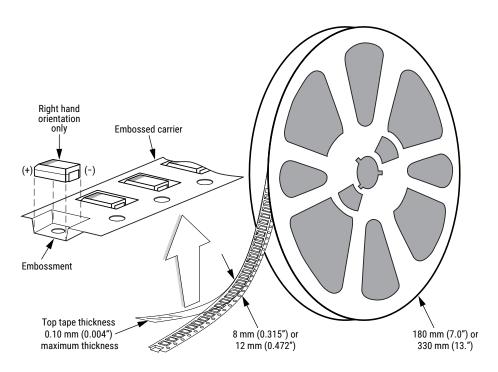


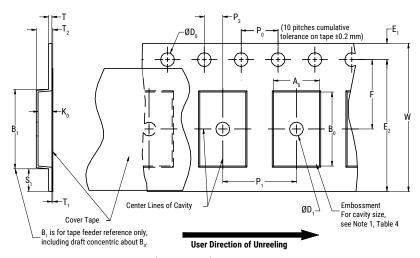
Table 3 - Packaging Quantity

Case Code		Tape Width (mm)	7" Reel*	13" Reel*	
KEMET	EIA				
S	3216-12	8	2,500	10,000	
T	3528-12	8	2,500	10,000	
М	3528-15	8	2,500	8,000	
U	6032-15	12	1,000	5,000	
L	6032-19	12	1,000	3,000	
W	7343-15	12	1,000	3,000	
Z	7343-17	12	1,000	3,000	
V	7343-20	12	1,000	3,000	
Α	3216-18	8	2,000	9,000	
В	3528-21	8	2,000	8,000	
С	6032-28	12	500	3,000	
D	7343-31	12	500	2,500	
Q	7343-12	12	1,000	3,000	
Υ	7343-40	12	500	2,000	
Х	7343-43	12	500	2,000	
E/T428P	7360-38	12	500	2,000	
Н	7360-20	12	1,000	2,500	
0	7360-43	12	250	1,000	

<sup>\*</sup> No C-Spec required for 7" reel packaging. C-7280 required for 13" reel packaging.



# Figure 1 – Embossed (Plastic) Carrier Tape Dimensions



**Table 4 - Embossed (Plastic) Carrier Tape Dimensions** 

Metric will govern

Constant Dimensions — Millimeters (Inches)									
Tape Size	D <sub>0</sub>	D <sub>1</sub> Minimum Note 1	E <sub>1</sub>	P <sub>0</sub>	P <sub>2</sub>	R Reference Note 2	S <sub>1</sub> Minimum Note 3	T Maximum	T <sub>1</sub> Maximum
8 mm	1.5 +0.10/-0.0	1.0 (0.039)	1.75 ±0.10	4.0 ±0.10	2.0 ±0.05	25.0 (0.984)	0.600	0.600	0.100
12 mm	(0.059 +0.004/-0.0)	1.5 (0.059)	(0.069 ±0.004)	(0.157 ±0.004)	(0.079 ±0.002)	30 (1.181)	(0.024)	(0.024)	(0.004)

Variable Dimensions — Millimeters (Inches)									
Tape Size	Pitch	B <sub>1</sub> Maximum Note 4	E <sub>2</sub> Minimum	F	P <sub>1</sub>	T <sub>2</sub> Maximum	W Maximum	A <sub>0</sub> , B <sub>0</sub> & K <sub>0</sub>	
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)		
12 mm	Single (4 mm) and Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	Note 5	

- 1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.
- 2. The tape, with or without components, shall pass around R without damage (see Figure 4).
- 3. If S<sub>1</sub> < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481–D, paragraph 4.3, section b).
- 4.  $B_1$  dimension is a reference dimension for tape feeder clearance only.
- 5. The cavity defined by  $A_{o}$ ,  $B_{o}$  and  $K_{o}$  shall surround the component with sufficient clearance that:
  - (a) the component does not protrude above the top surface of the carrier tape.
  - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
  - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes (see Figure 2).
  - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 mm and 12 mm wide tape (see Figure 3).
  - (e) see Addendum in EIA Standard 481-D for standards relating to more precise taping requirements.



## **Packaging Information Performance Notes**

1. Cover tape break force: 1.0 kg minimum.

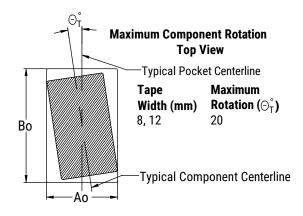
2. Cover tape peel strength: The total peel strength of the cover tape from the carrier tape shall be:

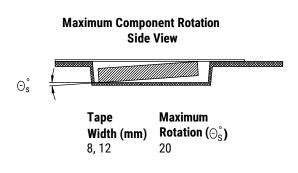
Tape Width	Peel Strength		
8 mm	0.1 to 1.0 newton (10 to 100 gf)		
12 mm	0.1 to 1.3 newton (10 to 130 gf)		

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ±10 mm/minute.

3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. Refer to EIA Standards 556 and 624.

#### Figure 2 - Maximum Component Rotation





# Figure 3 - Maximum Lateral Movement

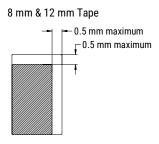


Figure 4 - Bending Radius

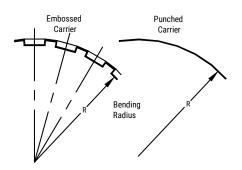
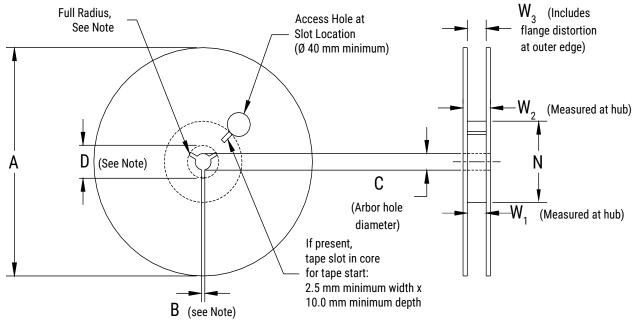




Figure 5 - Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

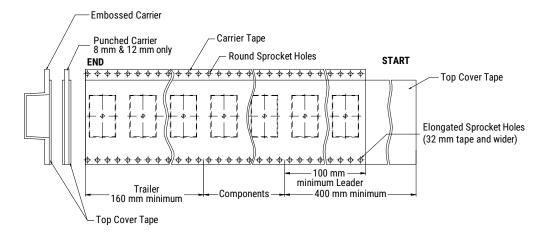
**Table 5 - Reel Dimensions** 

Metric will govern

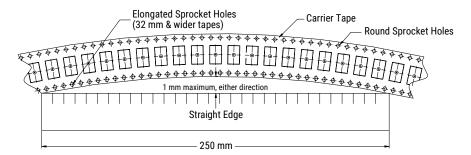
Constant Dimensions — Millimeters (Inches)									
Tape Size	A	B Minimum	С	D Minimum					
8 mm	178 ±0.20 (7.008 ±0.008)								
12 mm	or 330 ±0.20 (13.000 ±0.008)	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)					
	Variable Dimensions — Millimeters (Inches)								
Tape Size	N Minimum	W <sub>1</sub>	W <sub>2</sub> Maximum	W <sub>3</sub>					
8 mm	50	8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)	Shall accommodate tape					
12 mm	(1.969)	12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	width without interference					



# Figure 6 - Tape Leader & Trailer Dimensions



# Figure 7 – Maximum Camber





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